

New Jersey Semi-Conductor Products, Inc.

20 STERN AVE.
SPRINGFIELD, NEW JERSEY 07081
U.S.A.

TELEPHONE: (973) 376-2922
(212) 227-6005
FAX: (973) 376-8960

RFH25N18, RFH25N20

Power MOS Field-Effect Transistors

N-Channel Enhancement-Mode Power Field-Effect Transistors

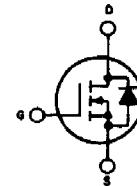
25 A, 180 V - 200 V

$r_{DS(on)} = 0.15 \Omega$

Features:

- SOA is power-dissipation limited
- Nanosecond switching speeds
- Linear transfer characteristics
- High input impedance
- Majority carrier device
- High-current, low-inductance package

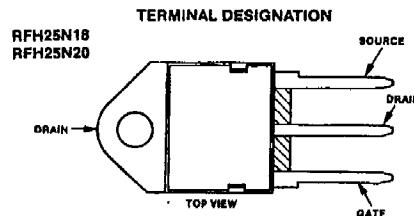
TERMINAL DIAGRAM



N-CHANNEL ENHANCEMENT MODE

The RFH25N18 and RFH25N20* are n-channel enhancement-mode silicon-gate power field-effect transistors designed for applications such as switching regulators, switching converters, motor drivers, relay drivers, and drivers for high-power bipolar switching transistors requiring high speed and low gate-drive power. These types can be operated directly from integrated circuits.

The RFH-types are supplied in the JEDEC TO-218AC plastic package.



JEDEC TO-218AC

MAXIMUM RATINGS, Absolute-Maximum Values ($T_c = 25^\circ C$):

	RFH25N18	RFH25N20	
DRAIN-SOURCE VOLTAGE	V _{DS}	180	200
DRAIN-GATE VOLTAGE, $R_{DS(on)} = 1 \Omega$	V _{GDR}	180	200
GATE-SOURCE VOLTAGE	V _{GS}	± 20	V
DRAIN CURRENT, RMS Continuous	I _D	25	A
Pulsed	I _{DM}	60	A
POWER DISSIPATION @ $T_c = 25^\circ C$	P _T	150	W
Derate above $T_c = 25^\circ C$		1.2	W/ $^\circ C$
OPERATING AND STORAGE TEMPERATURE	T _J , T _{STG}	-55 to +150	$^\circ C$

NJ Semi-Conductors reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by NJ Semi-Conductors is believed to be both accurate and reliable at the time of going to press. However, NJ Semi-Conductors assumes no responsibility for any errors or omissions discovered in its use. NJ Semi-Conductors encourages customers to verify that datasheets are current before placing orders.



RFH25N18, RFH25N20

ELECTRICAL CHARACTERISTICS, at Case Temperature (T_c) = 25°C unless otherwise specified.

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	LIMITS				UNITS	
			RFH25N18		RFH25N20			
			Min.	Max.	Min.	Max.		
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D = 1 \text{ mA}$ $V_{GS} = 0$	180	—	200	—	V	
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}$ $I_D = 1 \text{ mA}$	2	4	2	4	V	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 145 \text{ V}$	—	1	—	—	μA	
		$V_{DS} = 160 \text{ V}$	—	—	—	1		
		$T_c = 125^\circ\text{C}$ $V_{DS} = 145 \text{ V}$ $V_{DS} = 160 \text{ V}$	—	50	—	—		
Gate-Source Leakage Current	I_{GS}	$V_{GS} = \pm 20 \text{ V}$ $V_{DS} = 0$	—	100	—	100	nA	
Drain-Source On Voltage	$V_{DS(\text{on})}$	$I_D = 12.5 \text{ A}$ $V_{GS} = 10 \text{ V}$	—	1.875	—	1.875	V	
		$I_D = 25 \text{ A}$ $V_{GS} = 10 \text{ V}$	—	5	—	5		
Static Drain-Source On Resistance	$r_{DS(on)}$	$I_D = 12.5 \text{ A}$ $V_{GS} = 10 \text{ V}$	—	.15	—	.15	Ω	
Forward Transconductance	g_{f*	$V_{DS} = 10 \text{ V}$ $I_D = 12.5 \text{ A}$	7	—	7	—	mho	
Input Capacitance	C_{iss}	$V_{DS} = 25 \text{ V}$	—	3500	—	3500	pF	
		$V_{GS} = 0 \text{ V}$	—	900	—	900		
		$f = 1 \text{ MHz}$	—	400	—	400		
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = 100 \text{ V}$	40(typ)	80	40(typ)	80	ns	
Rise Time	t_r	$I_D = 12.5 \text{ A}$	150(typ)	225	150(typ)	225		
Turn-Off Delay Time	$t_{d(off)}$	$R_{DS(on)} = R_{DS(on)} = 50\Omega$	300(typ)	400	300(typ)	400		
Fall Time	t_f	$V_{GS} = 10 \text{ V}$	120(typ)	200	120(typ)	200		
Thermal Resistance Junction-to-Case	$R_{\theta_{JC}}$	RFH25N18, RFH25N20 Series	—	0.83	—	0.83	°C/W	

*Pulsed: Pulse duration = 300 μs max., duty cycle = 2%.

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

CHARACTERISTIC	TEST CONDITIONS	LIMITS				UNITS	
		RFH25N18		RFH25N20			
		Min.	Max.	Min.	Max.		
Diode Forward Voltage	V_{SD}	—	1.4	—	1.4	V	
Reverse Recovery Time	t_r	$I_F = 4 \text{ A}$, $dI/dt = 100 \text{ A}/\mu\text{s}$	300 (typ.)	300 (typ.)	300 (typ.)	ns	

* Pulse Test: Width $\leq 300 \mu\text{s}$, Duty cycle $\leq 2\%$.